



120 V power Schottky rectifier





TO-220AB

Features

- · High current capability
- Avalanche rated
- Low forward voltage drop current
- · High frequency operation
- ECOPACK®2 compliant

Applications

- · Switching diode
- SMPS
- DC/DC converter
- LED lighting
- Notebook adapter

Description

This Schottky rectifier is suited for high frequency switch mode power supply.

The voltage drop versus leakage current trade-off is in keeping with medium power hi-density adapter design.

Packed in TO-220AB, the STPS40M120C is optimized for use in notebook, game station and desktop adaptors, providing in these applications a good efficiency at both low and high load.

Product status link				
STPS40M120C				
Product summary				
Symbol Value				
2 x 20 A				
120 V				
150 °C				
0.61 V				



1 Characteristics

Table 1. Absolute Ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Param	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage			120	V
I _{F(RMS)}	Forward rms current			30	Α
	A	T _C = 130 °C	Per diode	20	_
I _{F(AV)}	Average forward current, $\delta = 0.5$	T _C = 120 °C	Per device	40	Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal		220	Α
P _{ARM}	Repetitive peak avalanche power $t_p = 10 \mu s$, $T_j = 125 °C$			1600	W
T _{stg}	Storage temperature range			-65 to +175	°C
Tj	Maximum operating junction temperature ⁽¹⁾			150	°C

^{1.} $(dP_{tot}/dT_i) < (1/R_{th(i-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

Symbol	Parameter	Value	Unit	
D.,	Junction to case	Per diode	1.10	
R _{th(j-c)}	Junction to case	Total	0.80	°C/W
R _{th(c)}	Coupling		0.50	

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_{j \text{ (diode1)}} = P_{\text{(diode1)}} x R_{\text{th(j-c)}} \text{ (per diode)} + P_{\text{(diode2)}} x R_{\text{th(c)}}$

For more information, please refer to the following application note:

· AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
. (1)	Reverse leakage current	T _j = 25 °C	j = 25 °C		75	370	μA
I _R ⁽¹⁾		T _j = 125 °C	$V_R = V_{RRM}$	-	25	70	mA
		T _j = 125 °C	I _F = 5 A	-	0.44	0.49	
V _F ⁽²⁾		T _j = 125 °C	I _F = 10 A	-	0.52	0.57	V
VF *	Forward voltage drop	T _j = 25 °C	I _E = 20 A	-		0.79	v
		T _j = 125 °C	IF - 20 A	-	0.61	0.67	

- 1. Pulse test: $t_p = 5$ ms, $\delta < 2\%$
- 2. Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses, use the following equation: P = 0.54 x $I_{F(AV)}$ + 0.0065 x I_{F} 2 (RMS) For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current (per diode)

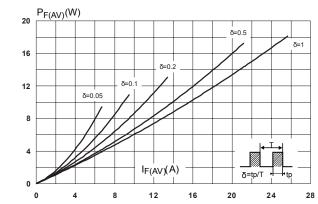


Figure 2. Average forward current versus ambient temperature (δ = 0.5, per diode)

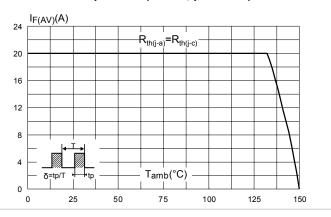


Figure 3. Normalized avalanche power derating versus pulse duration ($T_i = 125$ °C)

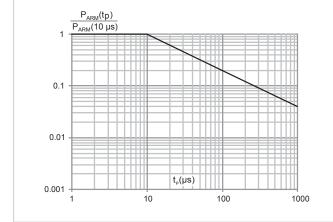
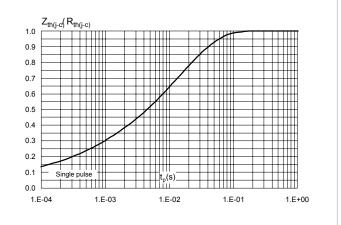


Figure 4. Relative variation of thermal impedance junction to case versus pulse duration



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Figure 5. Reverse leakage current versus reverse voltage applied (typical values, per diode)

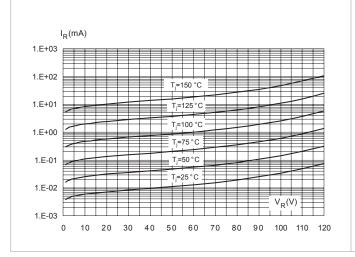


Figure 6. Junction capacitance versus reverse voltage applied (typical values, per diode)

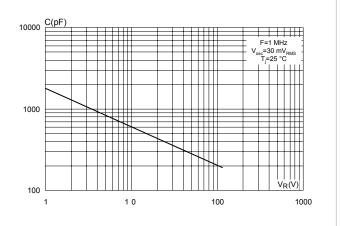
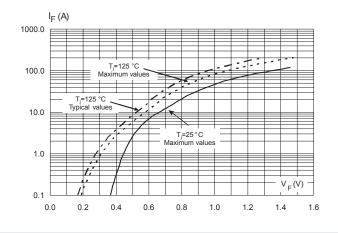


Figure 7. Forward voltage drop versus forward current (per diode)



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 TO-220AB package information

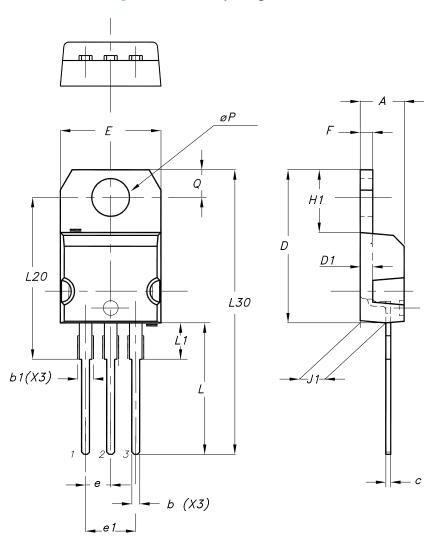
Epoxy meets UL 94,V0

Cooling method: by conduction (C)

Recommended torque value: 0.55 N·m

Maximum torque value: 0.70 N·m

Figure 8. TO-220AB package outline



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Table 4. TO-220AB package mechanical data

	Dimensions				
Ref.	Millimeters		Inches (for reference only)		
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.173	0.181	
b	0.61	0.88	0.240	0.035	
b1	1.14	1.55	0.045	0.061	
С	0.48	0.70	0.019	0.028	
D	15.25	15.75	0.600	0.620	
D1	1.27	7 typ.	0.050 typ.		
E	10.00	10.40	0.394	0.409	
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.195	0.203	
F	1.23	1.32	0.048	0.052	
H1	6.20	6.60	0.244	0.260	
J1	2.40	2.72	0.094	0.107	
L	13.00	14.00	0.512	0.551	
L1	3.50	3.93	0.138	0.155	
L20	16.40 typ.		0.646	typ.	
L30	28.90 typ.		1.138 typ.		
θР	3.75	3.85	0.148	0.152	
Q	2.65	2.95	0.104	0.116	

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3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS40M100CT	PS40M100CT	TO-220AB	1.95 g	50	Tube

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Revision history

Table 6. Document revision history

Date	Version	Changes
02-Apr-2012	1	First issue.
27-Jun-2018	2	Updated Table 1. Absolute Ratings (limiting values, per diode, at 25 °C, unless otherwise specified) and Figure 3. Normalized avalanche power derating versus pulse duration (T_j = 125 °C). Removed TO-220AB narrow leads and I²PAK package information.

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